



Dow Packaging & Specialty Plastics

Product Data Sheet

BYNEL™ 41E755

Adhesive Resin

General Information

Product Description BYNEL™ 4100 series resins are anhydride-modified, linear low-density polyethylene (LLDPE) resins. All 4100 series resins are available in pellet form for use in conventional extrusion and coextrusion equipment designed to process polyethylene (PE) resins.

Status

Material Status Commercial: Active

Typical Characteristics

Composition Low% By Weight Maleic Anhydride
Graft levels are defined as:
Low < 0.2%; Medium 0.2-0.5%; High 0.5-1.0%; Ultra high > 1.0%

Characteristics / Benefits Physical properties of BYNEL™ 4100 series resins are typical of linear low-density polyethylene resins with similar density and melt index values. Use of these adhesive resins in coextruded PE/barrier structures offers improved thermal resistance over that of ethylene vinyl acetate-based adhesive resins.

Applications BYNEL™ 41E755 is specifically designed to provide high adhesion to both metals and polyolefins when converted into film form and used as a thermal lamination film. It has a low coefficient of friction for easy film handling and provides strong bonds that fail cohesively.

Typical Properties

Physical	Nominal Values	Test Method(s)	
*Density ()	0.93 g/cm ³	ASTM D792	ISO 1183
*Melt Flow Index (190°C/2.16kg)	4.2 g/10 min	ASTM D1238	ISO 1133
Thermal	Nominal Values	Test Method(s)	
*Melting Point (DSC)	125 °C (257 °F)	ASTM D3418	ISO 3146
Freezing Point (DSC)	109 °C (228.2 °F)	ASTM D3418	ISO 3146
Vicat Softening Point ()	100 °C (212 °F)	ASTM D1525	ISO 306

Adhesive Evaluation The performance of any adhesive resin should be evaluated within the context of the application. The adhesive is designed to bond materials that would not ordinarily adhere to each other. In most cases, peel strength is used as a measure of performance. Although this is a convenient test, peel strength is affected not only by adhesion, but also by peel angle, separation rate, temperature, and tensile and modulus properties of the materials, and often by the time elapsed since the formation of the bond. Post-treatment of the multi-layer structure, such as heat sealing, thermoforming or orientation can also affect peel strength.

If peel strength is used as a measure of adhesive performance, it is imperative that peel strength be evaluated not only at the time of manufacture, but throughout the life of the product and under all the various conditions to which the structure will be exposed. Only then can the performance of the adhesive be related to peel strength.

Processing Information

*Maximum Processing Temperature 250 °C (482 °F)

General Processing Information The temperature profiles shown below are for initial evaluations of BYNEL™ 41E755 adhesive resin when extruded as a monofilm or in coextrusion with PE. If this resin is to be utilized in coextrusion as an adhesive with Nylon or EVOH, please consult

with your technical representative for a recommended processing guideline.

In coextrusions with thermally sensitive resins such as EVOH or EVA, we suggest that the maximum melt temperature be limited to 235C (455F) to guard against overheating the EVOH or EVA. If adhesion results are adequate, we suggest evaluating even lower melt temperatures such as 210 - 220C (410 - 428F).

For coextrusion with polyamides or other thermally stable resins, the melt temperature can be higher. We suggest a maximum melt temperature of 250C (482F). This should provide acceptable bond strengths and film quality under almost all coextrusion conditions. If adhesion results are adequate, melt temperatures can be lowered. While it is possible to extrude some BYNEL™ 4100 series resins as high as 300C (572F), for BYNEL™ 41E755 we suggest a maximum of only 250C (482F). Higher extrusion temperatures, particularly when coupled with long residence times, may result in some film imperfections. In certain streamlined extrusion operations, where residence times are short, it may be possible to use temperatures higher than 250C (482F).

Variation of these suggested temperature profiles may be appropriate depending upon the screw configuration, potential extruder horsepower limitations, potential back pressure limitations, the need to match rheologies and/or the stability of the other resins in the coextrusion. Film quality will also depend upon the residence time of the adhesive resin in the system. Dead spots may result in localized overheating and should be avoided by ensuring the flow path for the adhesive is as streamlined as possible.

We suggest using any standard polyolefin working screw when extruding BYNEL™ 4100 series resins. Excessively deep flights should be avoided as they might result in poor melting of the adhesive resin. It is also important to properly size the extruder for the output desired. Running large extruders at very low RPMs should be avoided.

For producing monolayer adhesive films with BYNEL™ 4100 series resins, extrusion conditions commonly used for converting linear low density polyethylene into films can be employed.

If the coextrusion process is stopped for short periods of time, the screw in the adhesive extruder should be kept turning at a low RPM level. For a permanent shutdown, the BYNEL™ adhesive resin should be purged out using an available polyethylene resin run at the same extrusion temperature used during the extrusion process of the adhesive resin. Making frequent changes in screw speed during the shutdown process and subsequent start-up will help remove the previous material from the system more effectively. Sometimes upon start-up of the adhesive resin, excessive amounts of gel may be observed. This may be due to the natural ability of the adhesive resin to act as a purging compound. In this case, continued extrusion will eventually clear up the problem.

Blown Film

Processing Information

Nominal Values

Proposed Extruder Set Temperatures for coextrusion with PE resins. If interested to coextrude this resin with EVOH or Nylon, please consult with your Dow technical representative.

Feed Zone	160 °C (320 °F)
Second Zone	185 °C (365 °F)
Third Zone	185 °C (365 °F)
Fourth Zone	185 °C (365 °F)
Fifth Zone	185 °C (365 °F)
Adapter Zone	185 °C (365 °F)
Die Zone	185 °C (365 °F)

FDA Status Information

BYNEL™ 41E755 Adhesive Resin complies with Food and Drug Administration Regulation 21 CFR 175.105 - - Adhesives. This Regulation describes adhesives that may be used as components of articles intended for use in packaging, transporting,

or holding food, subject to the limitations and requirements therein.

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For information on regulatory compliance outside the U.S.A., consult your local Dow representative.

Safety & Handling

For information on appropriate Handling & Storage of this polymeric resin, please refer to the material Safety Data Sheet.

A Product Safety Bulletin, material Safety Data Sheet, and/or more detailed information on extrusion processing and/or compounding of this polymeric resin for specific applications are available from your Dow representative.

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http://www.dow.com/products_services

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P&SP Disclaimer

Additional Information

To contact Dow via Toll-Free or Local Toll phone numbers in specific countries, please see the following webpage:

<https://www.dow.com/en-us/support/contact-representative.html>

<http://www.dow.com>

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